MN38663S

NTSC-Compatible CCD Video Signal Delay Element

Overview

The MN38663S is a CCD signal delay element for video signal processing applications.

It contains such components as a threefold-frequency circuit, a shift register clock driver, charge I/O blocks, two CCD analog shift registers switchable between 680.5 and 605 stages, a clamp bias circuit, resampling output amplifiers, and booster circuits.

When the switch input is "L" level, the MN38663S samples the input using the supplied clock signal with a frequency of three times the NTSC color signal subcarrier frequency (3.579545 MHz) and, after adding in the attached filter delay, produces independent delays of 1 H (the horizontal scan period) each for the two lines. When the switch input is "H" level, the MN38663S disables the threefold-frequency circuit and samples the input with the image sensor drive frequency (9.545454 MHz) for the camera's 510 horizontal pixels and, after adding in the attached filter delay, produces independent delays of 1 H (the horizontal scan period) each for the two lines.

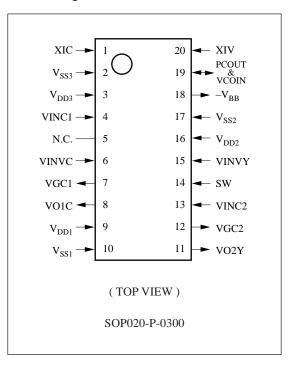
Features

- Single 4.4 V power supply
- Choice of camera and VCR modes, so that both the camera and VCR portions of a video camera with 510 horizontal pixels can use the same MN38663S for signal processing

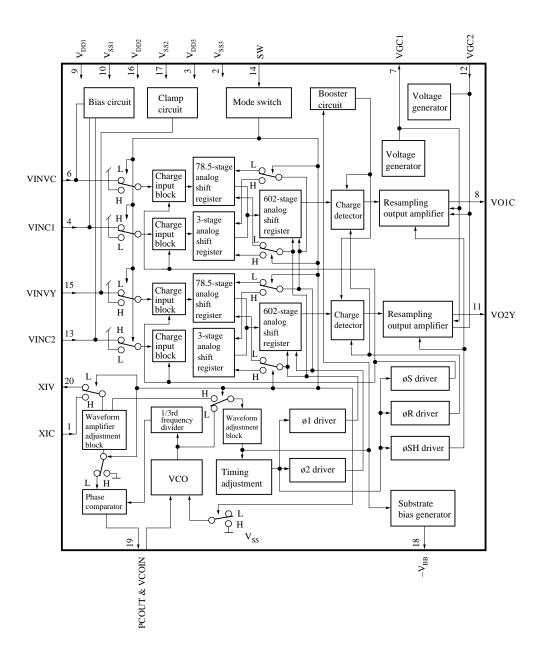
Applications

Video cameras

■ Pin Assignment



■ Block Diagram



■ Pin Descriptions

Pin No.	Symbol	Pin Name	Function Description			
1	XIC	9.545454 MHz clock input				
2	V_{SS3}	GND (3)	Ground for clock multiplier circuit			
3	V_{DD3}	Power supply (3)	Power supply for clock			
			multiplier circuit			
4	VINC1	Camera signal input (1)				
5	N.C.	No connection				
6	VINVC	Video signal input (C)				
7	VGC1	Output gate connection (1)				
8	VO1C	Signal output (1C)	Output pin for signal fed			
			to pin 4 or pin 6			
9	V_{DD1}	Power supply (1)	Power supply for analog circuits			
10	V_{SS1}	GND (1)	Ground for analog circuits			
11	VO2Y	Signal output (2Y)	Output pin for signal fed			
			to pin 13 or pin 15			
12	VGC2	Output gate connection (2)				
13	VINC2	Power supply (2)				
14	SW	Camera/video mode switch				
15	VINVY	Video signal input (Y)				
16	V_{DD2}	Power supply (2)	Power supply for digital circuits			
			other than frequency multiplier			
17	V_{SS2}	GND (2)	Ground for digital circuits other			
			than frequency multiplier			
18	$-V_{BB}$	Substrate connection	Negative voltage pin			
19	PCOUT&VCOIN	Phase comparator output and voltage controlled				
		oscillator input				
20	XIV	3.579545 MHz clock input				

Notes

^{1:} Always connect $\boldsymbol{V}_{DD1},\,\boldsymbol{V}_{DD2},$ and \boldsymbol{V}_{DD3} to the same voltage.

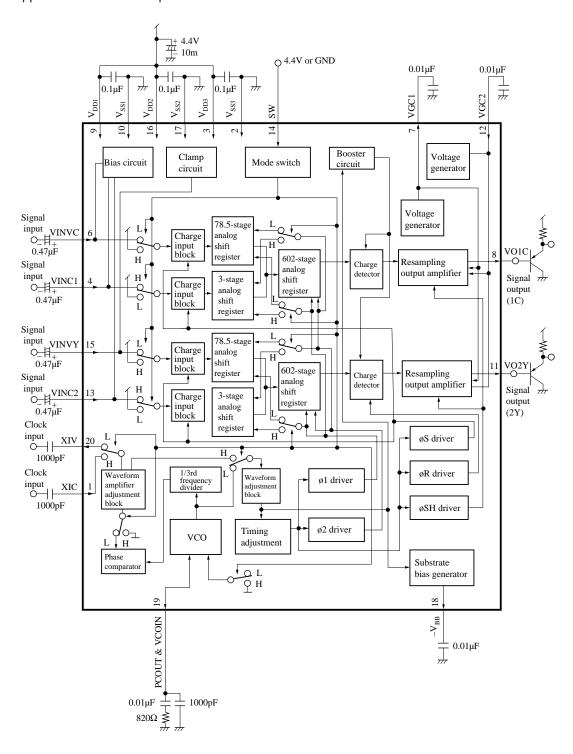
^{2:} Always connect $\boldsymbol{V}_{SS1},\,\boldsymbol{V}_{SS2},$ and \boldsymbol{V}_{SS3} to ground.

■ Electrical Characteristics

$$\begin{split} V_{DD}=&4.4\text{V}, V_{ckv}=&0.3\text{V}_{P\text{-P}}\text{ (sine wave)}, \text{ } f_{ckv}=&3.579545\text{MHz (Converted to } 10.738635\text{ MHz internally)} \\ V_{ckc}=&0.3\text{V}_{P\text{-P}}\text{ (sine wave)}, \text{ } f_{ckc}=&9.545454\text{MHz}, \text{V}_{in}=&0.5\text{V}_{P\text{-P}}\text{ (sine wave)}, \text{ } \text{Ta}=&25^{\circ}\text{C} \end{split}$$

Parameter	Symbol	Conditions	min	typ	max	Unit
Power supply current	ī	Average current for 4.4-V power		30	48	- mA
(Video signal I/O)	I_{DDV}	supply when SW is "L" level				
Power supply current	T	Average current for 4.4-V power		28	46	
(Camera signal I/O)	I_{DDC}	supply when SW is "H" level				
Signal bandwidth	DWW	-3 dB for 200 kHz value when	3.0	4.2		MHz
(Video signal I/O)	BWV	SW is "L" level				
Signal bandwidth	DWG	-3 dB for 200 kHz value when	2.7	3.7		
(Camera signal I/O)	BWC	SW is "H" level				
Insertion gain	IG	f _{sig} =200kHz	1	4	7	dB
Total harmonic distortion	THD	f _{sig} =200kHz		1	4	%
Signal-to-noise ratio	S/N	Signal output (V _{P-P})/noise output (rms)	50	56		dB
		3.579545-MHz component output/main			-40	dB
Clock leak (V1)	NCV1	output signal when SW is "L" level		-50		
		9.545454-MHz component output/main			-10	dB
Clock leak (C)	NCC	output signal when SW is "H" level		-15		
	NCV2	10.738635-MHz component output/main		-15	-10	dB
Clock leak (V2)		output signal when switch signal is "L" level				Ì
Crosstalk	CT	f _{sig} =200kHz			-37	dB
Delay (Video signal I/O)	$ au_{\mathrm{DV}}$	When SW is "L" level		63.40		
Delay (Camera signal I/O)	$ au_{ m DC}$	When SW is "H" level		63.42		μs
VO pin output impedance	ZO			350	700	Ω
Input bias voltage	V _{BINC}	Applicable to signal input pins	2.20 2.50	2.50	2.80	V
		VINC1 and VINC2		2.50		
Input bias voltage	V _{BINY}	Applicable to signal input pin VINC1	2.10	2.40	2.70	V
Input clamp voltage	V _{CLIN}	Applicable to signal input pin VINVY	1.90	2.20	2.50	V
0		Applicable to signal output pins VO1C	1.30	2.30	3.30	V
Output bias voltage	V_{BOC}	and VO2Y when SW is "H" level				
0	V _{BOY}	Applicable to signal output pin	1.35	2.35	3.35	V
Output bias voltage		VO1C when SW is "L" level				
0 4 4 1 14	V _{CLO}	Applicable to signal output pin	1.05	2.05	3.05	V
Output clamp voltage		VO2Y when SW is "L" level				
Substrate voltage	$-V_{BB}$			-2.5		V

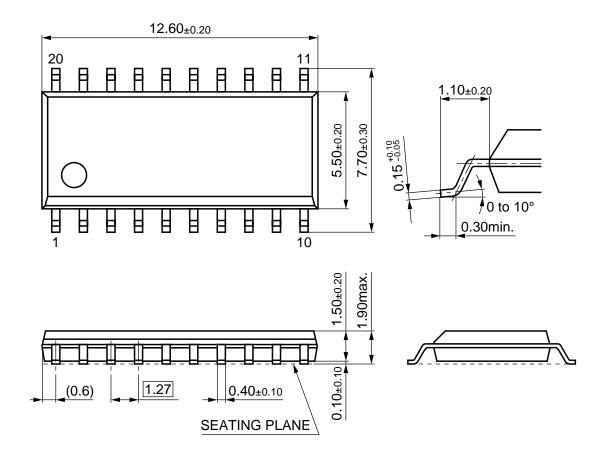
■ Application Circuit Example



Note: If the capacitor attached to pin 18 has a polarity, attach the negative pole to pin 18.

■ Package Dimensions (Unit:mm)

SOP020-P-0300



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